Product Information

Aug 2013

Ultradur® S 4090 G4
PBT (Polybutylene Terephthalate)

BASF The Chemical Company

Product Description

Ultradur S 4090 G4 is a 20% glass reinforced PBT+ASA blend. It produces moldings with good surface finish,is resistant to chemicals and stress cracking, and has low shrinkage and warpage.

Applications

Applications include highly stressed equipment housings in the automotive, electrical and household sectors.

PHYSICAL	ISO Test Method	Property Value
Density, g/cm	1183	1.39
Viscosity Number, cm/g	1628	105
Mold Shrinkage, parallel, %	294-4	0.43
Mold Shrinkage, normal, %	294-4	0.74
Moisture, %	62	
(50% RH)		0.2
(Saturation)		0.4
RHEOLOGICAL	**ISO Test Method**	**Property Value**
Melt Volume Rate (275 C/2.16 Kg), cc/10min.	1133	20
MECHANICAL	**ISO Test Method**	**Property Value**
Tensile Modulus, MPa	527	
23C		6,900
Tensile stress at break, MPa	527	
-40C		160
23C		100
80C		68
121C		42
Tensile strain at break, %	527	
23C		2.5
Flexural Modulus, MPa	178	
23C		6,400
Tensile Creep Modulus (1000h), MPa	899	4,700
Tensile Creep Modulus (1h), MPa	899	5,300
IMPACT	**ISO Test Method**	**Property Value**
Charpy Notched, kJ/m^2	179	
23C		7
Charpy Unnotched, kJ/m^2	179	
23C		55
-30C		43
THERMAL	**ISO Test Method**	**Property Value**
Melting Point, C	3146	223
HDT A, C	75	160
HDT B, C	75	205

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Coef. of Linear Thermal Expansion, Parallel, mm/mm C		.4 X10-4
ELECTRICAL	**ISO Test Method**	**Property Value**
Comparative Tracking Index	IEC 60112	450
Volume Resistivity	IEC 60093	>1E13
Surface Resistivity	IEC 60093	1E14
Dielectric Constant (100 Hz)	IEC 60250	3.7
Dielectric Constant (1 MHz)	IEC 60250	3.6
Dissipation Factor (100 Hz)	IEC 60250	30
Dissipation Factor (1 MHz)	IEC 60250	190
UL RATINGS	**UL Test Method**	**Property Value**
Flammability Rating, 1.5mm	UL94	HB
Relative Temperature Index, 1.5mm	UL746B	
Mechanical w/o Impact, C		130
Mechanical w/ Impact, C		90
Electrical, C		130

Processing Guidelines

Material Handling
Max. Water content: 0.04%
To ensure optimum part performance, this product must be dried prior to molding and maintained at a moisture level of less than 0.04%. Dehumidifying or desiccant dryers operating at 100-120 degC (212-248 degF) for 4 hours drying time are recommended. Further information concerning safe handling procedures can be obtained from the Material Safety Data Sheet. Alternatively, please contact your BASF representative.

Typical Profile
Melt Temperature 250-270 degC (482-518 degF)
Mold Temperature 60-100 degC (140-212 degF)
Injection and Packing Pressure 35-125 bar (500-1500 psi)

Mold Temperatures
This product can be processed over mold temperatures of 60-100 degC (140-212 degF); however, for optimizing surface appearance, dimensional stability and part performance, mold surface temperatures of at least 80 degC (176 degF) are preferred.

Pressures
Injection pressure controls the filling of the part and should be applied for 90% of ram travel. Packing pressure affects the final part and can be used effectively in controlling sink marks and shrinkage. It should be applied and maintained until the gate area is completely frozen off.

Back pressure can be utilized to provide uniform melt consistency and reduce trapped air and gas. A maximum of 10 bar (145 psi) is recommended due to the risk of excessive shear.

Fill Rate
Fast fill rates are recommended to ensure uniform melt delivery to the cavity and prevent premature freezing. Surface appearance is directly affected by injection rate.

Note

Note

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